

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KINGSUK MAITRA	05/20/2009
RECEIVING PARTY DATA	
Name:	ADVANCED MICRO DEVICES
Street Address:	7171 SOUTHWEST PARKWAY
Internal Address:	MAILSTOP B 100.3
City:	AUSTIN
State/Country:	TEXAS
Postal Code:	78735
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11837057
CORRESPONDENCE DATA	
Fax Number:	(561)989-9812
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	5619899811
Email:	patboca@fggbb.com
Correspondent Name:	FLEIT GIBBONS GUTMAN BONGINI & BIANCO PL
Address Line 1:	551 NW 77TH STREET
Address Line 2:	SUITE 111
Address Line 4:	BOCA RATON, FLORIDA 33487
ATTORNEY DOCKET NUMBER:	YOR920070243US1
NAME OF SUBMITTER:	STEPHEN BONGINI
Total Attachments: 2 source=YOR920070243US1_Assignment_AMD_5-20-09#page1.tif source=YOR920070243US1_Assignment_AMD_5-20-09#page2.tif	

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PATENT
REEL: 022712 FRAME: 0310

ASSIGNMENT

Whereas, the undersigned Inventor(s) has/have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") in:

Title of the Invention: **EXTREMELY-THIN SILICON-ON-INSULATOR TRANSISTOR WITH
RAISED SOURCE/DRAIN**

and further identified by the Attorney Docket Number provided above in the header of this Assignment, for which an application for a United States Patent was executed concurrently herewith or was filed having:

Serial Number: 11/837,057

Whereas, Advanced Micro Devices, a corporation of Delaware, having a place of business at Austin, Texas (herein referred to as "AMD"), desires to acquire, and each undersigned Inventor desires to grant to AMD, the entire worldwide right, title, and interest in and to the Invention and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency hereof being hereby acknowledged, each undersigned Inventor ("ASSIGNOR") hereby sells, assigns, and otherwise transfers to AMD (the "ASSIGNEE"), its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, each undersigned Inventor hereby authorizes and requests the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to AMD, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by AMD, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made; and each undersigned Inventor agrees to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in AMD, its successors, legal representatives, and assigns, whenever requested by AMD, its successors, legal representatives, or assigns.

Each undersigned Inventor acknowledges their prior and ongoing obligations to sell, assign, and transfer the rights under this Assignment to AMD and is unaware of any reason why they may not have the full and unencumbered right to sell, assign, and transfer the rights hereby sold, assigned, and transferred, and has not executed, and will not execute, any document or instrument in conflict herewith. Each undersigned Inventor also hereby grants AMD, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification (including, but not limited to, patent application Serial Number) which may be necessary or desirable for recordation of this Assignment.

This Assignment is governed by the substantive laws of the State of New York, and any disputes will be resolved in a New York state court or federal court sited in New York.

Executed by Inventor 1 of 1

Signature: Kingsuk Maitra
Kingsuk MAITRA

Date: 05/20/2009